GaAs-IR-Lumineszenzdiode GaAs Infrared Emitter

LD 271 LD 271 H LD 271 L LD 271 HL



Wesentliche Merkmale

- GaAs-LED mit sehr hohem Wirkungsgrad
- Hohe Zuverlässigkeit
- Gute spektrale Anpassung an Si-Fotoempfänger
- Gehäusegleich mit SFH 300, SFH 203

Anwendungen

- IR-Fernsteuerung von Fernseh- und Rundfunkgeräten, Videorecordern, Lichtdimmern
- Gerätefernsteuerungen für Gleich- und Wechsellichtbetrieb
- Sensorik
- Diskrete Lichtschranken

Features

- Very highly efficient GaAs-LED
- High reliability
- Spectral match with silicon photodetectors
- Same package as SFH 300, SFH 203

Applications

- IR remote control of hi-fi and TV-sets, video tape recorders, dimmers
- · Remote control for steady and varying intensity
- Sensor technology
- Discrete interrupters

Typ Type	Bestellnummer Ordering Code	Gehäuse Package
LD 271	Q62703-Q148	5-mm-LED-Gehäuse (T 1 ³ / ₄), graugetöntes Epoxy-
LD 271 L	Q62703-Q833	Gießharz, Lötspieße im 2.54-mm-Raster ($^{1}/_{10}$ ") 5 mm LED package (T 1 $^{3}/_{4}$), grey colored epoxy resin
LD 271 H	Q62703-Q256	lens, solder tabs lead spacing 2.54 mm ($\frac{1}{10}$)
LD 271 HL	Q62703-Q838	



Grenzwerte Maximum Ratings

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit	
Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{ m op};T_{ m stg}$	- 40 + 100	°C	
Sperrspannung Reverse voltage	V_{R}	5	V	
Durchlaßstrom Forward current	I_{F}	130	mA	
Stoßstrom, $t_p = 10 \mu s$, $D = 0$ Surge current	I_{FSM}	3.5	А	
Verlustleistung Power dissipation	P_{tot}	220	mW	
Wärmewiderstand Thermal resistance	R_{thJA}	330	K/W	

Kennwerte ($T_A = 25 \, ^{\circ}\text{C}$) **Characteristics**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Wellenlänge der Strahlung Wavelength at peak emission $I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms	$\lambda_{ m peak}$	950	nm
Spektrale Bandbreite bei 50% von $I_{\rm max}$ Spectral bandwidth at 50% of $I_{\rm max}$ $I_{\rm F}$ = 100 mA	Δλ	55	nm
Abstrahlwinkel Half angle	φ	± 25	Grad deg.
Aktive Chipfläche Active chip area	A	0.25	mm ²
Abmessungen der aktiven Chipfläche Dimensions of the active chip area	$L \times B \\ L \times W$	0.5 × 0.5	mm
Abstand Chipoberfläche bis Linsenscheitel Distance chip front to lens top	Н	4.0 4.6	mm
Schaltzeiten, $I_{\rm e}$ von 10% auf 90% und von 90% auf 10%, bei $I_{\rm F}$ = 100 mA, $R_{\rm L}$ = 50 Ω Switching times, $I_{\rm e}$ from 10% to 90% and from 90% to 10%, $I_{\rm F}$ = 100 mA, $R_{\rm L}$ = 50 Ω	t_{r},t_{f}	1	μs

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Kennwerte ($T_A = 25$ °C) Characteristics (cont'd)

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit	
Kapazität, $V_{\rm R}$ = 0 V, f = 1 MHz Capacitance	Co	40	pF	
Durchlaßspannung Forward voltage $I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms $I_{\rm F}$ = 1 A, $t_{\rm p}$ = 100 μ s	$V_{F} \ V_{F}$	1.30 (≤ 1.5) 1.90 (≤ 2.5)	V V	
Sperrstrom, $V_R = 5 \text{ V}$ Reverse current	I_{R}	0.01 (≤ 1)	μΑ	
Gesamtstrahlungsfluß Total radiant flux $I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms	Φ_{e}	18	mW	
Temperaturkoeffizient von $I_{\rm e}$ bzw. $\Phi_{\rm e}$, $I_{\rm F}$ = 100 mA Temperature coefficient of $I_{\rm e}$ or $\Phi_{\rm e}$, $I_{\rm F}$ = 100 mA	TC_1	- 0.55	%/K	
Temperaturkoeffizient von $V_{\rm F}$, $I_{\rm F}$ = 100 mA Temperature coefficient of $V_{\rm F}$, $I_{\rm F}$ = 100 mA	TC_{V}	- 1.5	mV/K	
Temperaturkoeffizient von λ , $I_{\rm F}$ = 100 mA Temperature coefficient of λ , $I_{\rm F}$ = 100 mA	TC_{λ}	0.3	nm/K	

Gruppierung der Strahlstärke I_e in Achsrichtung gemessen bei einem Raumwinkel $\Omega=0.01$ sr Grouping of Radiant Intensity I_e in Axial Direction at a solid angle of $\Omega=0.01$ sr

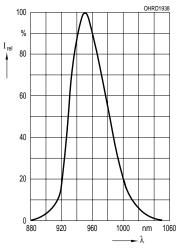
Bezeichnung Parameter	Symbol Symbol		Wert Value	
		LD 271 LD 271 L	LD 271 H LD 271 HL	
Strahlstärke Radiant intensity				
$I_{\rm F}$ = 100 mA, $t_{\rm p}$ = 20 ms $I_{\rm F}$ = 1 A, $t_{\rm p}$ = 100 μ s	$I_{\rm e}$ $I_{\rm e typ.}$	15 (≥ 10) 120	> 16	mW/sr mW/sr

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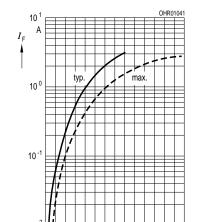


Relative Spectral emission

 $I_{rel} = f(\lambda)$

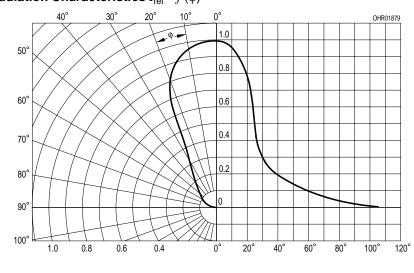


Forward Current $I_{\rm F} = f(V_{\rm F})$, single pulse, $t_{\rm p} = 20~{\rm \mu s}$



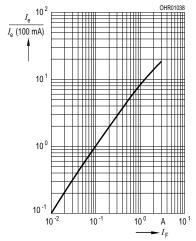
Radiation Characteristics $I_{rel} = f(\phi)$

2.5

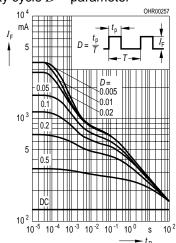


Radiant Intensity $\frac{I_{\rm e}}{I_{\rm e}\,{\rm 100~mA}}$ = f ($I_{\rm F}$)

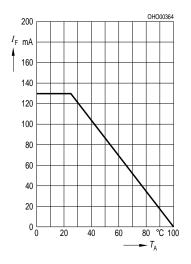
Single pulse, $t_p = 20 \mu s$



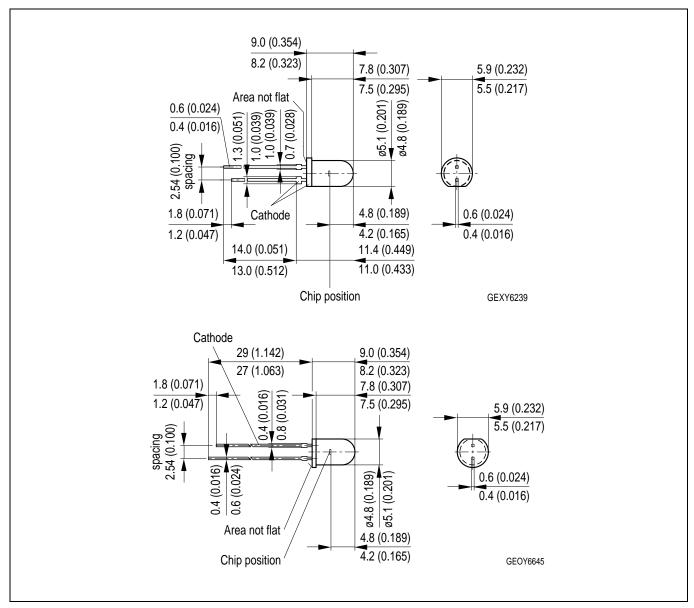
Permissible Pulse Handling Capability $I_{\rm F}$ = f (τ), $T_{\rm C}$ = 25 °C, duty cycle D = parameter



Max. Permissible Forward Current $I_{\rm F} = f\left(T_{\rm A}\right)$



Maßzeichnung Package Outlines



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

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